# 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

## General Description

The MAX2830 direct conversion, zero-IF, RF transceiver is designed specifically for 2.4 GHz to $2.5 \mathrm{GHz} 802.11 \mathrm{~g} / \mathrm{b}$ WLAN applications. The MAX2830 completely integrates all circuitry required to implement the RF transceiver function, providing an RF power amplifier (PA), an $R x / T x$ and antenna diversity switch, RF-to-baseband receive path, baseband-to-RF transmit path, voltage-controlled oscillator (VCO), frequency synthesizer, crystal oscillator, and baseband/control interface. The MAX2830 includes a fast-settling sigma-delta RF synthesizer with smaller than 20 Hz frequency steps and a digitally tuned crystal oscillator allowing use of a low-cost crystal. No I/Q calibration is required; however, the device also integrates on-chip DC-offset cancellation and I/Q errors and carrier leakage-detection circuits for improved performance. Only an RF bandpass filter (BPF), crystal, a pair of baluns, and a small number of passive components are needed to form a complete $802.11 \mathrm{~g} / \mathrm{b}$ WLAN RF frontend solution.

The MAX2830 completely eliminates the need for an external SAW filter by implementing on-chip monolithic filters for both the receiver and transmitter. The baseband filters are optimized to meet the IEEE 802.11 g standard and proprietary turbo modes up to 40 MHz channel bandwidth. These devices are suitable for the full range of 802.11 g OFDM data rates ( 6 Mbps to 54 Mbps ) and 802.11b QPSK and CCK data rates (1Mbps to 11Mbps). The ICs are available in a small, 48-pin TQFN package measuring only $7 \mathrm{~mm} \times 7 \mathrm{~mm} \times 0.8 \mathrm{~mm}$.

Applications
Wi-Fi, PDA, VOIP, and Cellular Handsets
Wireless Speakers and Headphones
General 2.4GHz ISM Radios

- 2.4GHz to 2.5 GHz ISM Band Operation
- IEEE 802.11g/b Compatible (54Mbps OFDM and 11 Mbps CCK)
- Complete RF Transceiver, PA, Rx/Tx and Antenna Diversity Switch, and Crystal Oscillator Best-in-Class Transceiver Performance 62mA Receiver Current
3.3dB Rx Noise Figure
-75dBm Rx Sensitivity (54Mbps OFDM)
No I/Q Calibration Required
$0.1 \mathrm{~dB} / 0.35^{\circ}$ Rx I/Q Gain/Phase Imbalance
33dB RF and 62dB Baseband Gain Control Range
60dB Range Analog RSSI per RF Gain Setting
Fast Rx I/Q DC-Offset Settling
Programmable Baseband Lowpass Filter
20-Bit Sigma-Delta Fractional-N PLL with < 20Hz Step Size
Digitally Tuned Crystal Oscillator
+17.1dBm Transmit Power (5.6\% EVM with 54Mbps OFDM)
31dB Tx Gain Control Range
Integrated Power Detector
Fully Integrated RF Input and Output
Matching and DC Blocking
Serial or Parallel Gain-Control Interface $>40 \mathrm{~dB}$ Tx Sideband Suppression Without Calibration
Rx/Tx I/Q Error Detection
- Transceiver Operates from +2.7V to +3.6V
- PA Operates from +2.7V to +4.2V
- Low-Power Shutdown Mode
- Small 48-Pin TQFN Package
( $7 \mathrm{~mm} \times 7 \mathrm{~mm} \times 0.8 \mathrm{~mm}$ )
Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
| :---: | :---: | :--- |
| MAX $2830 E T M+\mathrm{T}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 48 TQFN-EP* |

*EP = Exposed paddle.
+Denotes a lead(Pb)-free/RoHS-compliant package.
$T$ = Tape and reel.

Pin Configuration appears at end of data sheet.

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

# 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

## ABSOLUTE MAXIMUM RATINGS

$V_{C C T X P A, ~ V C C P A, ~ a n d ~ A N T ~}^{\text {_ }}$, to GND ...................-0.3V to +4.5 V Vcclna, Vcctxmx, Vccpll, Vcccp, Vccxtal, Vccvco, VCCRXVGA, VCCRXFL, and VCCRXMX_ to GND...-0.3V to +3.9 V B6, B7, B3, B2, SHDN, B5, CS, SCLK, DIN, B1, TUNE, B4, ANTSEL, TXBBI_, TXBBQ_, RXHP, RXTX, RXBBI_, RXBBQ_, RSSI, BYPASS, CPOUT, LD, CLOCKOUT, XTAL, CTUNE to GND ...................-0.3V to (Operating $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ )
RXBBI_, RXBBQ_, RSSI, BYPASS, CPOUT, LD, CLOCKOUT Short-Circuit Duration $\qquad$ .10s

| RF Input Power ............................................ Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ ) <br> 48-Pin TQFN (derates $27.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) $\ldots . . . . . .2 .22 \mathrm{~W}$ Operating Temperature Range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Junction Temperature <br> Storage Temperature Range $-65^{\circ} \mathrm{C}$ to $+160^{\circ} \mathrm{C}$ <br> Lead Temperature (soldering, 10s) <br> $+300^{\circ} \mathrm{C}$ <br> Soldering Temperature (reflow) |
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION! ESD SENSITIVE DEVICE

## DC ELECTRICAL CHARACTERISTICS

(MAX2830 EV kit, $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~V}_{\text {CCPA }}=\mathrm{V}_{\text {CCTXPA }}=2.7 \mathrm{~V}$ to $4.2 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, Rx set to the maximum gain. $\overline{\mathrm{CS}}=$ high, RXHP = SCLK = DIN = ANTSEL = low, RSSI and clock output buffer are off, no signal at RF inputs, all RF inputs and outputs terminated into $50 \Omega$, receiver baseband outputs are open. 100 mV RMS differential I and Q signals (54Mbps IEEE 802.11g OFDM) applied to I/Q baseband inputs of transmitter in transmit mode, $\mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}$, and registers set to recommended settings and corresponding test mode, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=2.8 \mathrm{~V}, \mathrm{~V}_{C C P A}=3.3 \mathrm{~V}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, LO frequency $=$ 2.437 GHz , unless otherwise noted. RF inputs/outputs specifications are referenced to device pins and do not include 1 dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETERS | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | VCC_ |  | 2.7 |  | 3.6 | V |
|  | VCCPA, VCCTXPA |  | 2.7 |  | 4.2 |  |
| Supply Current | Shutdown mode, B7: B1 $=0000000$, reference oscillator not applied | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 20 |  | $\mu \mathrm{A}$ |
|  | Standby mode | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 28 | 35 | mA |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | 35 |  |
|  | Rx mode | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 62 | 78 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | 82 |  |
|  | $\begin{aligned} & \mathrm{Tx} \text { mode, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \\ & \mathrm{~V}_{\mathrm{CC}}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}= \\ & \text { 3.3V (Note 2) } \\ & \hline \end{aligned}$ | Transmit section |  | 82 | 104 |  |
|  |  | PA, POUT $=+17.1 \mathrm{dBm}$ |  | 212 |  |  |
|  | Rx calibration mode | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 101 |  |  |
|  | Tx calibration mode | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 78 |  |  |
| Rx I/Q Output Common-Mode Voltage | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ at default common-mode setting |  | 0.94 | 1.2 | 1.37 | V |
| Rx I/Q Output Common-Mode Voltage Variation | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ (relative to $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ) |  |  | -17 |  | mV |
|  | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (relative to $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ) |  |  | 15 |  |  |
| Tx Baseband Input CommonMode Voltage Operating Range | DC-coupled |  | 0.9 |  | 1.3 | V |
| Tx Baseband Input Bias Current | Source current |  |  |  | 22 | $\mu \mathrm{A}$ |

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## DC ELECTRICAL CHARACTERISTICS (continued)

(MAX2830 EV kit, $\mathrm{VCC}_{-}=2.7 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~V}$ CCPA $=\mathrm{V}$ CCTXPA $=2.7 \mathrm{~V}$ to $4.2 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, Rx set to the maximum gain. $\overline{\mathrm{CS}}=$ high, RXHP = SCLK = DIN = ANTSEL = low, RSSI and clock output buffer are off, no signal at RF inputs, all RF inputs and outputs terminated into $50 \Omega$, receiver baseband outputs are open. 100 mV RMS differential I and Q signals (54Mbps IEEE 802.11g OFDM) applied to I/Q baseband inputs of transmitter in transmit mode, fREF $=40 \mathrm{MHz}$, and registers set to recommended settings and corresponding test mode, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=2.8 \mathrm{~V}, \mathrm{~V}_{C C P A}=3.3 \mathrm{~V}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, LO frequency $=$ 2.437 GHz , unless otherwise noted. RF inputs/outputs specifications are referenced to device pins and do not include 1 dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETERS | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS: $\overline{\text { SHDN, }}$ RXTX, SCLK, DIN, $\overline{\mathbf{C S}}$, B7:B1, RXHP, ANTSEL |  |  |  |  |  |
| Digital Input-Voltage High, $\mathrm{V}_{\text {IH }}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}- \\ 0.4 \end{gathered}$ |  |  | V |
| Digital Input-Voltage Low, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.4 | V |
| Digital Input-Current High, $\mathrm{IIH}^{\mathrm{H}}$ |  | -1 |  | +1 | $\mu \mathrm{A}$ |
| Digital Input-Current Low, I/L |  | -1 |  | +1 | $\mu \mathrm{A}$ |
| LOGIC OUTPUTS: LD, CLOCKOUT |  |  |  |  |  |
| Digital Output-Voltage High, $\mathrm{VOH}^{\text {OH}}$ | Sourcing 100 ${ }^{\text {A }}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}- \\ 0.4 \end{gathered}$ |  |  | V |
| Digital Output-Voltage Low, VOL | Sinking 100 ${ }^{\text {A }}$ |  |  | 0.4 | V |

## AC ELECTRICAL CHARACTERISTICS-Rx Mode

(MAX2830 EV kit, $\mathrm{V}_{C C}=2.8 \mathrm{~V}, \mathrm{~V} \mathrm{CCPA}=\mathrm{V}_{\mathrm{CCTXPA}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2.439 \mathrm{GHz}$, $\mathrm{fLO}=2.437 \mathrm{GHz}$; receiver baseband I/Q outputs at 112 mV RMS $(-19 \mathrm{dBV}), f_{\text {REF }}=40 \mathrm{MHz}, \overline{S H D N}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXTX}=$ SCLK $=\mathrm{DIN}=$ low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. RF inputs/outputs specifications are referenced to device pins and do not include 1 dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RECEIVER SECTION: LNA RF INPUT-TO-BASEBAND I/Q OUTPUTS |  |  |  |  |  |
| RF Input Frequency Range |  |  | 2.4 | 2.5 | GHz |
| RF Input Return Loss (ANT1) | High RF gain |  | 13 |  | dB |
|  | Mid RF gain |  | 16 |  |  |
|  | Low RF gain |  | 13 |  |  |
| RF Input Return Loss (ANT2) | High RF gain |  | 21 |  | dB |
|  | Mid RF gain |  | 14 |  |  |
|  | Low RF gain |  | 12 |  |  |
| Total Voltage Gain (ANT1) | Maximum gain, $\mathrm{B} 7: \mathrm{B} 1=$ 1111111 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $86 \quad 97$ |  | dB |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 83 |  |  |
|  | Minimum gain, B7:B1 = 0000000 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 2 | 8 |  |
| Total Voltage Gain (ANT2) | Maximum gain, B7:B1 = 1111111 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 96 |  | dB |
|  | Minimum gain, B7:B1 = 0000000 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 2 |  |  |

### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS-Rx Mode (continued)

(MAX2830 EV kit, $\mathrm{VCC}_{-}=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fRF}=2.439 \mathrm{GHz}, \mathrm{fLO}=2.437 \mathrm{GHz}$; receiver baseband I/Q outputs at 112 mV RMS $(-19 \mathrm{dBV}), \mathrm{f}_{\text {REF }}=40 \mathrm{MHz}, \overline{S H D N}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXTX}=\mathrm{SCLK}=\mathrm{DIN}=$ low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. RF inputs/outputs specifications are referenced to device pins and do not include 1dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)


### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS—Rx Mode (continued)

(MAX2830 EV kit, $\mathrm{VCC}_{C}=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fRF}=2.439 \mathrm{GHz}$, fLO $=2.437 \mathrm{GHz}$; receiver baseband I/Q outputs at 112 mV RMS $(-19 \mathrm{dBV}), \mathrm{f}_{\text {REF }}=40 \mathrm{MHz}, \overline{S H D N}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXTX}=\mathrm{SCLK}=\mathrm{DIN}=$ low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. RF inputs/outputs specifications are referenced to device pins and do not include 1dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| I/Q Output DC Droop | After switching RXHP to 0, D13:D12, Register 7 (A3:AO = 0111) |  | $\pm 1$ |  | V/s |
| I/Q Static DC Offset | $\mathrm{RXHP}=1, \mathrm{~B} 7: \mathrm{B} 1=1101110,1 \sigma$ variation |  | $\pm 1$ |  | mV |
| Spurious Signal Emissions from LNA input | $\mathrm{RF}=1 \mathrm{GHz}$ to 26.5 GHz |  | -51 |  | dBm |
| ANT to Receiver Isolation | ANT1 to receiver (in ANT2 mode) |  | 20 |  | dB |
|  | ANT2 to receiver (in ANT1 mode) |  | 47 |  |  |
| RECEIVER BASEBAND FILTERS |  |  |  |  |  |
| Gain Ripple in Passband | 10 kHz to 8.5 MHz at baseband |  | $\pm 1.3$ |  | dBP-p |
| Group-Delay Ripple in Passband | 10 kHz to 8.5 MHz at baseband |  | $\pm 45$ |  | nsp-p |
| Baseband Filter Rejection (Nominal Mode) | At 8.5 MHz |  | 3.2 |  | dB |
|  | At 15 MHz |  | 27 |  |  |
|  | At 20 MHz |  | 50 |  |  |
|  | At $>40 \mathrm{MHz}$ |  | 80 |  |  |
| RSSI |  |  |  |  |  |
| RSSI Minimum Output Voltage | RLOAD $\geq 10 \mathrm{k} \Omega \\| 5 \mathrm{pF}$ |  | 0.4 |  | V |
| RSSI Maximum Output Voltage | RLOAD $\geq 10 \mathrm{k} \Omega \\| 5 \mathrm{pF}$ |  | 2.4 |  | V |
| RSSI Slope | To within 3dB of steady $\quad+32 \mathrm{~dB}$ signal step |  | 30 |  | $\mathrm{mV} / \mathrm{dB}$ |
| RSSI Output Settling Time |  |  | 200 |  | ns |
|  | To within 3dB of steady state | -32dB signal step | 600 |  |  |

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS-Tx Mode

$\left(\mathrm{MAX2830} \mathrm{EV}\right.$ kit, $\mathrm{VCC}_{-}=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fRF}=2.439 \mathrm{GHz}, \mathrm{fLO}=2.437 \mathrm{GHz} . \mathrm{fREF}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=$ RXTX $=\overline{\mathrm{CS}}=$ ANTSEL $=$ high, and SCLK $=$ DIN $=$ low, with power matching for the differential RF pins using the typical applications circuit. 100 mV RMS sine and cosine signal (or 100 mV RMS 54 Mbps IEEE $802.11 \mathrm{~g} \mathrm{I} / \mathrm{Q}$ signals wherever OFDM is mentioned) applied to baseband I/Q inputs of transmitter (differential DC-coupled). Registers set to recommend settings and corresponding test mode, unless otherwise noted. RF inputs/outputs specifications are referenced to device pins and do not include 1 dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETER | CONDITIONS |  |  |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TRANSMIT SECTION: Tx BASEBAND I/Q INPUTS TO RF OUTPUTS |  |  |  |  |  |  |  |  |
| RF Output Frequency Range |  |  |  |  | 2.4 |  | 2.5 | GHz |
| Output Power | 54Mbps 802.11g OFDM signal |  | Output power adjusted to meet 5.6\%EVM, and spectral mask |  |  | 17.1 |  | dBm |
|  | 6Mbits, OFDM, I/Q signals |  | Output power adjusted to meet spectral mask |  |  | 20.3 |  |  |
| Gain Control Range | B6:B1 $=000000$ to 111000 |  |  |  |  | 26 |  | dB |
| Unwanted Sideband Suppression | Without I/Q calibration, B6:B1 = 100001 |  |  |  |  | -42 |  | dBc |
| Carrier Leakage at Center Frequency of Channel | Without DC offset correction |  |  |  |  | -30 |  | dBc |
| Transmitter Spurious Signal Emissions | $\begin{aligned} & \text { B6:B1 = 111000, } \\ & \text { OFDM signal } \end{aligned}$ | $1 / 3 \times \mathrm{fLO}$ |  |  |  | -67 |  | dBm/MHz |
|  |  | $<1 \mathrm{GHz}$ |  |  |  | -36 |  |  |
|  |  | > 1GHz |  |  |  | -47 |  |  |
|  |  | $2 / 3 \times \mathrm{fLO}$ |  |  |  | -64 |  |  |
|  |  | $4 / 3 \times \mathrm{fLO}$ |  |  |  | -42 |  |  |
|  |  | $5 / 3 \times \mathrm{fLO}$ |  |  |  | -65 |  |  |
|  |  | $8 / 3 \times \mathrm{fLO}$ |  |  |  | -55 |  |  |
|  |  | $2 \times \mathrm{fLO}$ |  |  |  | -27 |  |  |
|  |  | $3 \times \mathrm{fLO}$ |  |  |  | -54 |  |  |
| RF Output Return Loss | Off-chip balun and single ended |  |  |  |  | -15 |  | dB |
| Tx I/Q Input Load Impedance ( $\mathrm{R} \\| \mathrm{C}$ ) | Minimum differential resistance |  |  |  |  | 20 |  | $\mathrm{k} \Omega$ |
|  | Maximum differential capacitance |  |  |  |  | 0.7 |  | pF |
| Baseband -3dB Corner Frequency | $\begin{aligned} & \text { D1:D0 = 01, Register } 8 \\ & \text { (A3:A0 = 1000) } \end{aligned}$ |  |  | Nominal mode |  | 11 |  | MHz |
| Baseband Filter Rejection | At 30MHz, in nominal mode |  |  |  |  | 62 |  | dB |
| Minimum Power-Detector Output Voltage | Short sequence transmitter power $=+10 \mathrm{dBm}$ |  |  |  |  | 0.35 |  | V |
| Maximum Power-Detector Output Voltage | Short sequence transmitter power $=+20 \mathrm{dBm}$ |  |  |  |  | 1.2 |  | V |
| RF Power-Detector Response Time |  |  |  |  |  | 0.3 |  | $\mu \mathrm{s}$ |

# 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

## AC ELECTRICAL CHARACTERISTICS-Tx Mode (continued)

(MAX2830 EV kit, $\mathrm{VCC}_{C}=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fRF}=2.439 \mathrm{GHz}, \mathrm{fLO}=2.437 \mathrm{GHz} . \mathrm{fREF}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=$ RXTX $=\overline{\mathrm{CS}}=$ ANTSEL $=$ high, and SCLK $=$ DIN = low, with power matching for the differential RF pins using the typical applications circuit. 100 mV RMS sine and cosine signal (or 100 mV RMS 54 Mbps IEEE $802.11 \mathrm{~g} \mathrm{I} / \mathrm{Q}$ signals wherever OFDM is mentioned) applied to baseband I/Q inputs of transmitter (differential DC-coupled). Registers set to recommend settings and corresponding test mode, unless otherwise noted. RF inputs/outputs specifications are referenced to device pins and do not include 1dB loss from EV kit PCB, balun, and SMA connectors.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TRANSMITTER LO LEAKAGE AND I/Q CALIBRATION USING LO LEAKAGE AND SIDEBAND DETECTOR (see the Rx/Tx Calibration Mode section) |  |  |  |  |  |  |
| Tx BASEBAND I/Q INPUTS TO RECEIVER OUTPUTS |  |  |  |  |  |  |
| LO Leakage and Sideband Detector Output | $\begin{aligned} & \text { Calibration register, } \\ & \text { D12:D11 }=00, \\ & \text { A3:A0 }=0110 \end{aligned}$ | $\begin{aligned} & \text { Output at } 1 \times \text { fTONE (for LO } \\ & \text { leakage }=-29 \mathrm{dBc} \text { ), } \\ & \text { fTONE }=2 \mathrm{MHz}, 100 \mathrm{mV} \text { RMS } \end{aligned}$ |  | -34 |  | $\mathrm{dBV}_{\text {RMS }}$ |
|  |  | Output at $2 \times$ fTONE (for LO leakage $=-240 \mathrm{dBc}$ ), <br> $\mathrm{fTONE}=2 \mathrm{MHz}, 100 \mathrm{mV}$ RMS |  | -44 |  |  |
| Amplifier Gain Range | D12:D11 = 00 to D12:D11 = 11, A3:A0 = 0110 |  |  | 30 |  | dB |
| Lower -3dB Corner Frequency |  |  |  | 1 |  | MHz |

### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS-Frequency Synthesizer

(MAX2830 EV kit, $\mathrm{VCC}_{-}=2.7 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fLO}=2.437 \mathrm{GHz}$, fREF $=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{SCLK}=$ DIN = low, PLL loop bandwidth $=150 \mathrm{kHz}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FREQUENCY SYNTHESIZER |  |  |  |  |  |  |
| RF Channel Center Frequency |  |  | 2.4 |  | 2.5 | GHz |
| Channel Center Frequency Programming Minimum Step Size |  |  | 20 |  |  | Hz |
| Charge-Pump Comparison Frequency |  |  | 20 |  |  | MHz |
| Reference Frequency Range |  |  | 20 |  | 44 | MHz |
| Reference Frequency Input Levels | AC-coupled to XTAL pin |  | 800 |  |  | mVP-P |
| Reference Frequency Input Impedance ( R \|| C) | Resistance (XTAL) |  | 5 |  |  | $\mathrm{k} \Omega$ |
|  | Capacitance (XTAL) |  | 4 |  |  | pF |
| Closed-Loop Phase Noise | fofFSET $=1 \mathrm{kHz}$ |  | -86 |  |  | $\mathrm{dBc} / \mathrm{Hz}$ |
|  | foffset $=10 \mathrm{kHz}$ |  | -94 |  |  |  |
|  | fofFSET $=100 \mathrm{kHz}$ |  | -94 |  |  |  |
|  | foFFSET $=1 \mathrm{MHz}$ |  | -110 |  |  |  |
|  | foFFSET $=10 \mathrm{MHz}$ |  | -120 |  |  |  |
| Closed-Loop Integrated Phase Noise | RMS phase jitter; integrate from 10 kHz to 10 MHz offset |  | 0.9 |  |  | Degrees |
| Charge-Pump Output Current |  |  |  | 1 |  | mA |
| Reference Spurs | 20MHz offset |  |  | -55 |  | dBc |
| VCO Frequency Error | Measured from Tx-Rx or Rx-Tx transition | $3 \mu \mathrm{~s}$ to $9 \mu \mathrm{~s}$ | 50 |  |  | kHz |
|  |  | > $9 \mu \mathrm{~s}$ |  |  |  |  |
| VOLTAGE-CONTROLLED OSCILLATOR |  |  |  |  |  |  |
| Pushing | Referred to $2400 \mathrm{MHz} \mathrm{LO}, \mathrm{V}_{\text {cc }}$ varies by 0.3 V |  | 210 |  |  | kHz |
| LO Tuning Gain | $\mathrm{V}_{\text {TUNE }}=0.5 \mathrm{~V}$ |  |  | 103 |  | MHz/V |
|  | $V_{\text {TUNE }}=2.2 \mathrm{~V}$ |  | 86 |  |  |  |

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS-Miscellaneous Blocks

$\left(\right.$ MAX2830 EV kit, $\mathrm{VCC}_{-}=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{fLO}=2.437 \mathrm{GHZ}, \mathrm{fREF}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{SCLK}=\mathrm{DIN}=$ low, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CRYSTAL OSCILLATOR |  |  |  |  |  |
| On-Chip Tuning Capacitance Range | Maximum capacitance, $\mathrm{A} 3: \mathrm{AO}=1110, \mathrm{D} 6: \mathrm{DO}=1111111$ |  | 15.4 |  | pF |
|  | Minimum capacitance, $\mathrm{A}: \mathrm{AO}=1110, \mathrm{D} 6: \mathrm{DO}=0000000$ |  | 0.5 |  |  |
| On-Chip Tuning Capacitance Step Size |  |  | 0.12 |  | pF |
| ON-CHIP TEMPERATURE SENSOR |  |  |  |  |  |
| Output Voltage | $A 3: A 0=1000, D 9: D 8=01$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ | 0.35 |  | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1 |  |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ | 1.6 |  |  |

## AC ELECTRICAL CHARACTERISTICS-Timing

(MAX2830 EV kit, $\mathrm{V}_{C C}=2.8 \mathrm{~V}, \mathrm{~V} C \mathrm{CPA}=\mathrm{V}_{\text {CCTXPA }}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{SCLK}=$ DIN = low, PLL loop bandwidth $=150 \mathrm{kHz}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 1)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SYSTEM TIMING (see Figure 3) |  |  |  |  |  |  |
| Turn-On Time | From $\overline{\text { SHDN }}$ rising edge to LO settled within 1 kHz using external reference frequency input |  |  | 60 |  | $\mu \mathrm{s}$ |
| Crystal Oscillator Turn-On Time | 90\% of final output amplitude level |  |  | 1 |  | ms |
| Channel Switching Time | Loop BW = 150kHz, frF $=2.5 \mathrm{GHz}$ to 2.4 GHz |  |  | 25 |  | $\mu \mathrm{s}$ |
| Rx/Tx Turnaround Time | Measured from Tx or Rx enable rising edge; signal settling to within $\pm 2 \mathrm{~dB}$ of steady state | Rx to Tx |  | 2 |  |  |
|  |  | Tx to Rx, RXHP = 1 |  | 2 |  |  |
| Tx Turn-On Time (from Standby Mode) | From Tx-enable active rising edge; signal settling to within $\pm 2 \mathrm{~dB}$ of steady state |  |  | 1.5 |  | $\mu \mathrm{S}$ |
| Tx Turn-Off Time (from Standby Mode) | From Tx-enable inactive rising edge |  |  | 1 |  | $\mu \mathrm{s}$ |
| Rx Turn-On Time (from Standby Mode) | From Rx-enable active rising edge; signal settling to within $\pm 2 \mathrm{~dB}$ of steady state |  |  | 1.9 |  | $\mu \mathrm{S}$ |
| Rx Turn-Off Time (from Standby Mode) | From Rx-enable inactive rising edge |  |  | 0.1 |  | $\mu \mathrm{s}$ |

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## AC ELECTRICAL CHARACTERISTICS—Timing (continued)

(MAX2830 EV kit, VCC_ $=2.8 \mathrm{~V}, \mathrm{VCCPA}=\mathrm{VCCTXPA}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fLO}^{2}=2.437 \mathrm{GHz}, \mathrm{fREF}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{SCLK}=$ DIN = low, PLL loop bandwidth $=150 \mathrm{kHz}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 1)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 3-WIRE SERIAL-INTERFACE TIMING (see Figure 2) |  |  |  |  |  |
| SCLK Rising Edge to $\overline{\mathrm{CS}}$ Falling Edge Wait Time, tcso |  |  | 6 |  | ns |
| Falling Edge of $\overline{\mathrm{CS}}$ to Rising Edge of First SCLK Time, tcss |  |  | 6 |  | ns |
| DIN to SCLK Setup Time, tDS |  |  | 6 |  | ns |
| DIN to SCLK Hold Time, tDH |  |  | 6 |  | ns |
| SCLK Pulse-Width High, tch |  |  | 6 |  | ns |
| SCLK Pulse-Width Low, tCL |  |  | 6 |  | ns |
| Last Rising Edge of SCLK to Rising Edge of $\overline{\mathrm{CS}}$ or Clock to Load Enable Setup Time, tcSH |  |  | 6 |  | ns |
| $\overline{\overline{C S}}$ High Pulse Width, tcsw |  |  | 20 |  | ns |
| Time Between the Rising Edge of $\overline{\mathrm{CS}}$ and the Next Rising Edge of SCLK, tcs 1 |  |  | 6 |  | ns |
| Clock Frequency, fCLK |  |  | 20 |  | MHz |
| Rise Time, tR |  |  | 2 |  | ns |
| Fall Time, tF |  |  | 2 |  | ns |

Note 1: Min and max limits are guaranteed by test above $T_{A}=+25^{\circ} \mathrm{C}$ and guaranteed by design and characterization at $T_{A}=-40^{\circ} \mathrm{C}$.
The power-on register settings are not production tested. Recommended register setting must be loaded after VCC is supplied.
Note 2: Guaranteed by design and characterization.
Note 3: The nominal part-to-part variation of the RF gain step is $\pm 1 \mathrm{~dB}$.
Note 4: Two tones at +25 MHz and +48 MHz offset with $-35 \mathrm{dBm} /$ tone. Measure IM 3 at 2 MHz .
Note 5: Tx I/Q inputs $=100 \mathrm{mV}$ RMs.

### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Typical Operating Characteristics
(MAX2830 EV kit, $\mathrm{V}_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\text {CCTXPA }}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{fLO}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXHP}=$ SCLK = DIN = low.)


Rx IN-BAND OUTPUT P - 1dB vs. GAIN


OFDM EVM WITH OFDM JAMMER vs. OFFSET FREQUENCY


NOISE FIGURE
vs. BASEBAND GAIN SETTINGS


Rx EVM vs. PIN


Rx EMISSION SPECTRUM, LNA INPUT


Rx VOLTAGE GAIN vs. BASEBAND GAIN SETTING


Rx EVM vs. Vout


LNA INPUT RETURN LOSS vs. RF FREQUENCY (ANT 1)


## MAX2830

2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Typical Operating Characteristics (continued)
$\left(\mathrm{MAX2830} \mathrm{EV}\right.$ kit, $\mathrm{V}_{\mathrm{CC}}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ TXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, RXHP $=$ SCLK = DIN = low.)


### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## Typical Operating Characteristics (continued)

$\left(\right.$ MAX2830 EV kit, $V_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ TXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXHP}=$ SCLK = DIN = low.)


MAX2830]
2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## Typical Operating Characteristics (continued)

$\left(\right.$ MAX2830 EV kit, $V_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ TXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXHP}=$ SCLK = DIN = low.)


### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## Typical Operating Characteristics (continued)

$\left(\right.$ MAX2830 EV kit, $V_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ TXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, $\mathrm{RXHP}=$ SCLK = DIN = low.)


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2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Typical Operating Characteristics (continued)
$\left(\right.$ MAX2830 EV kit, $V_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ CXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, RXHP $=$ SCLK = DIN = low.)


LO PHASE NOISE vs. OFFSET FREQUENCY


PLL SETTLING TIME FROM SHUTDOWN TO STANDBY MODE


CHANNEL SWITCHING FREQUENCY SETTLING (FROM 2500MHz TO 2400MHz)


PLL SETTLING TIME FROM STANDBY TO Tx


### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## Typical Operating Characteristics (continued)

$\left(\right.$ MAX2830 EV kit, $\mathrm{V}_{C C}=2.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCPA}}=\mathrm{V}_{\mathrm{CC}}$ TXPA $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{LO}}=2.437 \mathrm{GHz}, \mathrm{f}_{\mathrm{REF}}=40 \mathrm{MHz}, \overline{\mathrm{SHDN}}=\overline{\mathrm{CS}}=$ high, RXHP $=$ SCLK = DIN = low.)


Tx-Rx TURNAROUND PLL SETTLING TIME


CRYSTAL-OSCILLATOR OFFSET FREQUENCY vs. CRYSTAL-OSCILLATOR TUNING BITS


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2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Block Diagram/Typical Operating Circuit


### 2.4GHz to 2.5 GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :---: |
| 1 | VCCLNA | LNA Supply Voltage |
| 2 | GNDRXLNA | LNA Ground |
| 3 | B6 | Receiver and Transmitter Gain-Control Logic-Input Bit 6 |
| 4 | ANT1+ | Antenna 1. Differential Input to LNA in Rx mode. Input is internally AC-coupled and matched to $100 \Omega$ differential. Connect directly to a 2:1 balun. |
| 5 | ANT1- |  |
| 6 | B7 | Receiver Gain-Control Logic-Input Bit 7 |
| 7 | VCCPA | Supply Voltage for Second Stage of Power Amplifier |
| 8 | B3 | Receiver and Transmitter Gain-Control Logic-Input Bit 3 |
| 9 | ANT2+ | Antenna 2. Differential inputs to LNA in diversity Rx mode and to PA differential outputs in Tx mode. Internally AC-coupled differential outputs and matched to $100 \Omega$ differential. Connect directly to a 2:1 balun. |
| 10 | ANT2- |  |
| 11 | B2 | Receiver and Transmitter Gain-Control Logic-Input Bit 2 |
| 12 | SHDN | Active-Low Shutdown and Standby Logic Input. See Table 32 for operating modes. |
| 13 | VCCTXPA | Supply Voltage for First-Stage of PA and PA Driver |
| 14 | B5 | Receiver and Transmitter Gain-Control Logic-Input Bit 5 |
| 15 | $\overline{\mathrm{CS}}$ | Active-Low Chip-Select Logic Input of 3-Wire Serial Interface (see Figure 3) |
| 16 | RSSI | RSSI, PA Power Detector or Temperature-Sensor Multiplexed Analog Output |
| 17 | Vсстхмх | Transmitter Upconverter Supply Voltage |
| 18 | SCLK | Serial-Clock Logic Input of 3-Wire Serial Interface (see Figure 3) |
| 19 | DIN | Data Logic Input of 3-Wire Serial Interface (see Figure 3) |
| 20 | VCCPLL | PLL and Registers Supply Voltage. Connect to the supply voltage to retain the register settings. |
| 21 | CLOCKOUT | Reference Clock Buffer Output |
| 22 | LD | Lock-Detect Logic Output of Frequency Synthesizer. Output high indicates that the frequency synthesizer is locked. Output programmable as CMOS or open-drain output. (See Tables 17 and 21.) |
| 23 | B1 | Receiver and Transmitter Gain-Control Logic-Input Bit 1 |
| 24 | CPOUT | Charge-Pump Output. Connect the frequency synthesizer's loop filter between CPOUT and TUNE (see the Block Diagram/Typical Operating Circuit). |
| 25 | VCCCP | PLL Charge-Pump Supply Voltage |
| 26 | GNDCP | Charge-Pump Circuit Ground |
| 27 | VCCXTAL | Crystal Oscillator Supply Voltage |
| 28 | XTAL | Crystal or Reference Clock Input. AC-couple a crystal or a reference clock to this analog input. |
| 29 | CTUNE | Connection for Crystal Oscillator Off-Chip Capacitors. When using an external reference clock input, leave CTUNE unconnected. |
| 30 | Vccvco | VCO Supply Voltage |
| 31 | GNDVCO | VCO Ground |
| 32 | TUNE | VCO TUNE Input (see the Block Diagram/Typical Operating Circuit) |
| 33 | BYPASS | On-Chip VCO Regulator Output Bypass. Bypass with a $0.1 \mu \mathrm{~F}$ to $1 \mu \mathrm{~F}$ capacitor to GND. Do not connect other circuitry to this point. |
| 34 | B4 | Receiver and Transmitter Gain-Control Logic-Input Bit 4 |

Pin Description (continued)

| PIN | NAME |  |
| :---: | :---: | :--- |
| 35 | RXBBQ- | Receiver Baseband Q-Channel Differential Outputs. In TX calibration mode, these pins are the LO leakage |
| 36 | RXBBQ+ | and sideband detector outputs. |

## Detailed Description

The MAX2830 single-chip, low-power, direct conversion, zero-IF transceiver is designed to support $802.11 \mathrm{~g} / \mathrm{b}$ applications operating in the 2.4 GHz to 2.5 GHz band The fully integrated transceivers include a receive path, transmit path, VCO, sigma-delta fractional-N synthesizer, crystal oscillator, RSSI, PA power detector, temperature sensor, Rx and Tx I/Q error-detection circuitry, basebandcontrol interface, linear power amplifier, and an $R \times / T x$ antenna diversity switch. The only additional components required to implement a complete radio front-end solution are a crystal, a pair of baluns, a BPF, and a small number of passive components (RCs, no inductors required).

## Rx/Tx and Antenna Diversity Switches

 The MAX2830 integrates an Rx/Tx switch and an antenna diversity switch before the receiver and after the power amplifier. See Figure 1 for a block diagram of the switches. The receiver and transmitter enable pin (RXTX) and the antenna selection pin (ANTSEL) determine which ports (ANT1 or ANT2) the receiver or transmitter is connected to. See Table 1 for the Rx/Tx and antenna diversity switches truth table. When RXTX $=0$

Figure 1. Simplified Rx/Tx and Antenna Diversity Switch Structure
(receive mode) and ANTSEL $=0$, the switch provides a low-insertion loss path (main) between the ANT1 port (pins 4 and 5) and the receiver. When RXTX $=0$ (receive mode) and ANTSEL = 1, the switch provides

Table 1. Rx/Tx and Antenna Diversity Switches Operation

| RXTX | ANTSEL | MODE | ANTENNA |
| :---: | :---: | :---: | :---: |
| 0 | 0 | Rx (main) | Ant1_ |
| 0 | 1 | Rx (diversity) | Ant2_ |
| 1 | X | Tx | Ant2_ |

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an antenna diversity path between the ANT2 port (pins 9 and 10) and the receiver. When RXTX $=1$, the PA and transmit path are automatically connected to the ANT2 port, regardless of the logic state of ANTSEL. For solutions not requiring antenna diversity, set ANTSEL logic-level high, enabling only the ANT2 port for both receive and transmit modes.
The ANT1 and ANT2 differential ports are internally ACcoupled and internally matched to $100 \Omega$. Directly connect 2:1 baluns or balanced bandpass filters (BPFs) to these ports for applications requiring antenna diversity. For applications not requiring antenna diversity, only a single balun or balanced BPF is required on the ANT2 port, and the ANT1 port can be left open. Provide electrically symmetrical input traces to the baluns to maintain IP2 and RF common-mode noise rejection for the receiver, and to maintain a balanced load for the PA.

## Receiver

After the switch, the receiver integrates an LNA and VGA with a 95dB digitally programmable gain control range, direct-conversion downconverters, I/Q baseband lowpass filters with programmable LPF corner frequencies, analog RSSI and integrated DC-offset correction circuitry. A logic-low on the RXTX input (pin 48) and a logic-high on the SHDN input (pin 12) enable the receiver.

## LNA Gain Control

The LNA has three gain modes: max gain, max gain $-16 d B$, and max gain $-33 d B$. The three LNA gain modes can be serially programmed through the $\mathrm{SPI}^{\text {TM }}$

Table 2. LNA Gain-Control Settings (Pins B7:B6 or Register A3:A0 = 1011, D6:D5)

| B7 OR D6 | B6 OR D5 | NAME | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 1 | 1 | High | Max gain |
| 1 | 0 | Medium | Max gain - 16dB (typ) |
| 0 | $X$ | Low | Max gain - 33dB (typ) |

Table 3. Receiver Baseband VGA GainStep Value (Pins B5:B1 or Register D4:D0, A3:A0 = 1011)

| PIN/BIT | GAIN STEP (dB) |
| :---: | :---: |
| B1/D0 | 2 |
| B2/D1 | 4 |
| B3/D2 | 8 |
| B4/D3 | 16 |
| B5/D4 | 32 |

SPI is a trademark of Motorola, Inc.
interface by programming bits D6:D5 in Register 11 ( $\mathrm{A} 3: \mathrm{A0}=1011$ ) or programmed in parallel through the digital logic gain-control pins, B7 (pin 6) and B6 (pin 3). Set bit D12 $=1$ in Register $8(\mathrm{~A} 3: \mathrm{A} 0=1000)$ to enable programming through the SPI interface, or set bit D12 = 0 to enable parallel programming. See Table 2 for LNA gain-control settings.

## Baseband Variable-Gain Amplifier

The receiver baseband variable-gain amplifiers provide 62 dB of gain control range programmable in 2 dB steps. The VGA gain can be serially programmed through the SPI interface by setting bits D4:D0 in Register 11 (A3:A0 $=1011$ ) or programmed in parallel through the digital logic gain-control pins, B5 (pin 14), B4 (pin 34), B3 (pin 8), $B 2$ (pin 11), and B1 (pin 23). Set bit D12 $=1$ in Register $8(\mathrm{~A} 3: A 0=1000)$ to enable serial programming through the serial interface or set bit D12 = 0 to enable parallel programming through the external logic pins. See Table 3 for the gain-step value and Table 4 for baseband VGA gain-control settings.

Receiver Baseband Lowpass Filter The receiver integrates lowpass filters that provide an upper -3 dB corner frequency of 8.5 MHz (nominal mode) with 50 dB of attenuation at 20 MHz , and 45 ns of group delay ripple in the passband ( 10 kHz to 8.5 MHz ). The upper -3dB corner frequency is tightly controlled on-chip and does not require user adjustment. However, provisions are made to allow fine tuning of the upper -3 dB

Table 4. Baseband VGA Gain-Control Settings in Receiver Gain-Control Register (Pin B5:B1 or Register D4:D0, A3:A0 = 1011)

| B5:B1 OR D4:D0 | GAIN |
| :---: | :---: |
| 11111 | $\operatorname{Max}$ |
| 11110 | $\operatorname{Max}-2 \mathrm{~dB}$ |
| 11101 | $\operatorname{Max}-4 \mathrm{~dB}$ |
| $:$ | $:$ |
| 00000 | $\operatorname{Min}$ |

Table 5. Receiver LPF Coarse -3dB Corner Frequency Settings in Register (A3:A0 = 1000)

| BITS (D1:D0) | -3dB CORNER <br> FREQUENCY (MHz) | MODE |
| :---: | :---: | :---: |
| 00 | 7.5 | 11 b |
| 01 | 8.5 | 11 g |
| 10 | 15 | Turbo 1 |
| 11 | 18 | Turbo 2 |

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corner frequency. In addition, coarse frequency tuning allows the -3 dB corner frequency to be set to 7.5 MHz (11b mode), 8.5 MHz (11g mode), 15 MHz (turbo 1 mode), and 18 MHz (turbo 2 mode) by programming bits D1:D0 in Register $8(\mathrm{A3}: \mathrm{A0}=1000)$. See Table 3. The coarse corner frequency can be fine-tuned approximately $\pm 10 \%$ in 5\% steps by programming bits D2:D0 in Register 7 (A3:A0 = 0111). See Table 6 for receiver LPF fine -3dB corner frequency adjustment.

## Baseband Highpass Filter and DC Offset Correction

 The receiver implements programmable AC and nearDC coupling of I/Q baseband signals. Temporary ACcoupling is used to quickly remove LO leakage and other DC offsets that could saturate the receiver outputs. When DC offsets have settled, near DC-coupling is enabled to avoid attenuation of the received signal. AC-coupling is set (-3dB highpass corner frequency of 600 kHz ) when a logic-high is applied to RXHP (pin 40). Near DC-coupling is set (-3dB highpass corner frequency of 100 Hz nominal) when a logic-low is applied to RXHP. Bits D13:D12 in Register 7 (A3:A0 = 0111) allow the near DC-coupling -3B highpass corner frequency to be set to $100 \mathrm{~Hz}(\mathrm{D} 13: \mathrm{D} 12=00), 4 \mathrm{kHz}$ (D13:D12 = X1), or 30kHz (D13:D12 = 10). See Table 7.
## Table 6. Receiver LPF Fine -3dB Corner Frequency Adjustment in Register (A3:A0 = 0111)

| BITS (D2:DO) | \% ADJUSTMENT RELATIVE TO <br> COARSE SETTING |
| :---: | :---: |
| 000 | 90 |
| 001 | 95 |
| 010 | 100 |
| 011 | 105 |
| 100 | 110 |

Table 7. Receiver Highpass Filter -3dB Corner Frequency Programming

| RXHP | A3:A0 = 0111, <br> D13:D12 | -3dB HIGHPASS CORNER <br> FREQUENCY (Hz) |
| :---: | :---: | :---: |
| 1 | XX | 600 k |
| 0 | 00 | 100 (recommended) |
| 0 | X 1 | 4 k |
| 0 | 10 | 30 k |

[^0]
## Receiver I/Q Baseband Outputs

The differential outputs ( $\mathrm{RXBBI}+$, RXBBI-, RXBBQ+, RXBBQ-) of the baseband amplifiers have a differential output impedance of $\sim 300 \Omega$, and are capable of driving differential loads up to $10 \mathrm{k} \Omega \| 10 \mathrm{pF}$. The outputs are internally biased to a common-mode voltage of 1.2 V and are intended to be DC-coupled to the inphase (I) and quadrature (Q) analog-to-digital data converter inputs of the accompanying baseband IC. Additionally, the common-mode output voltage can be adjusted from 1.2 V to 1.5 V through programming bits D11:D10 in Register 15 (A3:A0 = 1111).

Received Signal-Strength Indicator (RSSI)
The RSSI output (pin 16) can be programmed to multiplex an analog output voltage proportional to the received signal strength, the PA output power, or the die temperature. Set bits D9:D8 $=00$ in Register 8 $(A 3: A 0=1000)$ to enable the RSSI output in receive mode (off in transmit mode). Set bit D10 $=1$ to enable the RSSI output when RXHP = 1, and disable the RSSI output when RXHP $=0$. Set bit D10 $=0$ to enable the RSSI output independent of RXHP. See Table 8 for a summary of the RSSI output vs. register programming and RXHP.
The RSSI provides an analog voltage proportional to the log of the sum of the squares of the I and Q channels, measured after the receive baseband filters and before the variable-gain amplifiers. The RSSI analog output voltage is proportional to the RF input signal level and LNA gain state over a 60dB range, and is not dependent upon VGA gain. See the Rx RSSI Output vs. Input Power graph in the Typical Operating Characteristics for further details.

Table 8. RSSI Pin Truth Table

| INPUT CONDITIONS |  |  | RSSI OUTPUT |
| :---: | :---: | :---: | :---: |
| A3:A0 = 1000, <br> D9:D8 | A3:A0 = 1000, <br> D10 | RXHP |  |
| $X$ | 0 | 0 | No signal |
| 00 | 0 | 1 | RSSI |
| 01 | 0 | 1 | Temperature <br> sensor |
| 10 | 0 | 1 | Power detector |
| 00 | 1 | $X$ | RSSI |
| 01 | 1 | $X$ | Temperature <br> sensor |
| 10 | 1 | $X$ | Power detector |

[^1]
# 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

## Transmitter

The transmitter integrates baseband lowpass filters, direct-upconversion mixers, a VGA, a PA driver, and a linear RF PA with a power detector. A logic-high on the RXTX input (pin 48) and a logic-high on the SHDN input (pin 12) enable the transmitter. The PA outputs are routed to ANT2, regardless of the state at ANTSEL.

## Transmitter I/Q Baseband Inputs

The differential analog inputs of the transmitter baseband amplifier I/Q inputs (TXBBI+, TXBBI-, TXBBQ+, TXBBQ-) have a differential impedance of $20 \mathrm{k} \Omega \| 1 \mathrm{pF}$. The inputs require an input common-mode voltage of 0.9 V to 1.3 V , which is provided by the DC-coupled I and Q DAC outputs of the accompanying baseband IC.

## Transmitter Baseband Lowpass Filtering

 The transmitter integrates lowpass filters that can be tuned to -3 dB corner frequencies of $8 \mathrm{MHz}(11 \mathrm{~b})$, $11 \mathrm{MHz}(11 \mathrm{~g}), 16.5 \mathrm{MHz}$ (turbo 1 mode), and 22.5 MHz (turbo 2 mode) through programming bits D1:D0 inRegister $8(\mathrm{~A} 3: \mathrm{A0}=1000)$ and bit $\mathrm{D} 5: \mathrm{D} 3$ in Register 7 (A3:A0 $=0111$ ). The -3 dB corner frequency is tightly controlled on-chip and does not require user adjustment. Additionally, provisions are made to fine tune the -3dB corner frequency through bits D5:D3 in the Filter Programming register $(A 3: A 0=0111)$. See Tables 9 and 10.

Transmitter Variable-Gain Amplifier
The variable-gain amplifier of the transmitter provides 31 dB of gain control range programmable in 0.5 dB steps over the top 8 dB of the gain control range and in 1 dB steps below that. The transmitter gain can be programmed serially through the SPI interface by setting bits D5:D0 in Register $12(\mathrm{A3}: A 0=1100)$ or in parallel through the digital logic gain-control pins B6:B1 (pins $3,6,8,11,14,23$, and 34, respectively). Set bit D10 = 0 in Register $9(\mathrm{~A} 3: \mathrm{AO}=1001)$ to enable parallel programming, and set bit D10 = 1 to enable programming through the 3-wire serial interface. See Table 11 for the transmitter VGA gain-control settings.

Table 9. Transmitter LPF Coarse -3dB Corner Frequency Settings in Register (A3:A0 = 1000)

| BITS (D1:D0) | -3dB CORNER <br> FREQUENCY (MHz) | MODE |
| :---: | :---: | :---: |
| 00 | 8 | 11 b |
| 01 | 11 | 11 g |
| 10 | 16.5 | Turbo 1 |
| 11 | 22.5 | Turbo 2 |

Table 10. Transmitter LPF Fine -3dB Corner Frequency Adjustment in Register (A3:A0 = 0111)

| BITS (D5:D3) | \% ADJUSTMENT RELATIVE TO <br> COARSE SETTING |
| :---: | :---: |
| 000 | 90 |
| 001 | 95 |
| 010 | 100 |
| 011 | 105 |
| 100 | $110(11 \mathrm{~g})$ |
| 101 | 115 |
| $101-111$ | Not used |

## Table 11. Transmitter VGA Gain-Control Settings

| NO. | D5:D0 OR <br> B6:B1 | OUTPUT SIGNAL POWER |
| :---: | :---: | :---: |
| 63 | 111111 | Max |
| 62 | 111110 | Max -0.5 dB |
| 61 | 111101 | Max -1.0 dB |
| $:$ | $:$ | $:$ |
| 49 | 110001 | Max -7 dB |
| 48 | 110000 | Max -7.5 dB |
| 47 | 101111 | Max -8 dB |
| 46 | 101110 | Max -8 dB |
| 45 | 101101 | Max -9 dB |
| 44 | 101100 | Max -9 dB |
| $:$ | $:$ | $:$ |
| 5 | 000101 | Max -29 dB |
| 4 | 000100 | Max -29 dB |
| 3 | 000011 | Max -30 dB |
| 2 | 000010 | Max -30 dB |
| 1 | 000001 | Max -31 dB |
| 0 | 000000 | Max -31 dB |

## MAX2830

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

## Power-Amplifier Bias and Enable Delay

The MAX2830 integrates a 2 -stage PA, providing +17.1 dBm of output power at $5.6 \%$ error vector magnitude (EVM) (54Mbps OFDM signal) in 802.11 g mode while exceeding the 802.11 g spectral mask requirements. The first and second stage PA bias currents are set through programming bits D2:D0 and bits D6:D3 in Register 10 (A3:A0 = 1010), respectively. An adjustable PA enable delay, relative to the transmitter enable (RXTX low-to-high transition), can be set from 200ns to $7 \mu \mathrm{~s}$ through programming bits D13:D10 in Register 10 (A3:A0 = 1010).

## Power Detector

The MAX2830 integrates a voltage-peak detector at the PA output and before the switch to provide an analog voltage proportional to PA output power. See the Power Detector over Frequency and Power Detector over Supply Voltage graphs in the Typical Operating Characteristics. Set bits D9:D8 = 10 in Register 8 (A3:A0 $=$ 1000) to multiplex the power-detector analog output voltage to the RSSI output (pin 16).

## Synthesizer Programming

The MAX2830 integrates a 20-bit sigma-delta fractionalN synthesizer, allowing the device to achieve excellent phase-noise performance ( $0.9^{\circ} \mathrm{RMS}$ from 10 kHz to 10 MHz ), fast PLL settling times, and an RF frequency step-size of 20 Hz . The synthesizer includes a divide-by-

1 or a divide-by-2 reference frequency divider, an 8-bit integer portion main divider with a divisor range programmable from 64 to 255, and a 20-bit fractional portion main-divider. Bit D2 in Register 5 (A3:A0 = 0101) sets the reference oscillator divider ratio to 1 or 2 . Bits D7:D0 in Register $3(A 3: A 0=0011)$ set the integer portion of the main divider. The 20-bit fractional portion of the main-divider is split between two registers. The 14 MSBs of the fractional portion are set in Register 4 (A3:A0 $=0100$ ), and the 6 LSBs of the fractional portion of the main divider are set in Register 3 (A3:A0 = 0011). See Tables 12 and 13.

## Calculating Integer and Fractional Divider Ratios

 The desired integer and fractional divider ratios can be calculated by dividing the RF frequency ( $\mathrm{f}_{\mathrm{RF}}$ ) by $\mathrm{f}_{\mathrm{COMP}}$. For nominal $802.11 \mathrm{~g} / \mathrm{b}$ operation, a 40 MHz reference oscillator is divided by 2 to generate a 20 MHz comparison frequency ( $f_{\mathrm{COMP}}$ ). The following method can be used when calculating divider ratios supporting various reference and comparison frequencies:$$
\begin{gathered}
\qquad \begin{array}{c}
\text { LO Frequency Divider }=f_{\mathrm{RF}} / \mathrm{f}_{\mathrm{COMP}}=2437 \mathrm{MHz} / \\
20 \mathrm{MHz}=121.85 \\
\text { Integer Divider }=121(\mathrm{~d})=01111001 \text { (binary) } \\
\text { Fractional Divider }=0.85 \times\left(2^{20}-1\right)=891289 \text { (decimal) } \\
=11011001100110011001
\end{array}
\end{gathered}
$$

See Table 14 for integer and fractional divider ratios for $802.11 \mathrm{~g} / \mathrm{b}$ systems using a 20 MHz comparison frequency.

Table 12. Integer Divider Register (A3:A0 = 0011)

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D8 | 000000 | 6 LSBs of 20-Bit Fractional Portion of Main Divider |
| D7:D0 | 01111001 | 8-Bit Integer Portion of Main Divider. Programmable from 64 to 255. |

Table 13. Fractional Divider Register ( $\mathrm{A} 3: \mathrm{AO}=0100$ )

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D0 | 11011001100110 | 14 MSBs of 20-Bit Fractional Portion of Main Divider |

# 2.4GHz to $2.5 \mathrm{GHz} 802.11 \mathrm{~g} / \mathrm{b}$ RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

Table 14. IEEE 802.11g/b Divider-Ratio Programming Words

| $\mathbf{f}_{\mathbf{R F}}$ <br> $\mathbf{( M H z )}$ | (fRF / fcomp) | INTEGER DIVIDER | FRACTIONAL DIVIDER |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | A3:A0 = 0011, D7:D0 | A3:A0 = 0100, D13:D0 | A3:A0 = 0011, D13:D8 |
| 2412 | 120.6 | 01111000 b | 2666 h | 1 Ah |
| 2417 | 120.85 | 01111000 b | 3666 h | 1 Ah |
| 2422 | 121.1 | 01111001 b | 0666 h | 1 Ah |
| 2427 | 121.35 | 01111001 b | 1666 h | 1 Ah |
| 2432 | 121.6 | 01111001 b | 2666 h | 1 Ah |
| 2437 | 121.85 | 01111001 b | 3666 h | 1 Ah |
| 2442 | 122.1 | 01111010 b | 0666 h | 1 Ah |
| 2447 | 122.35 | 01111010 b | 1666 h | 1 Ah |
| 2452 | 122.6 | 01111010 b | 2666 h | 1 Ah |
| 2457 | 122.85 | 01111010 b | 3666 h | 1 Ah |
| 2462 | 123.1 | 01111011 b | 0666 h | 1 Ah |
| 2467 | 123.35 | 01111011 b | 1666 h | 1 Ah |
| 2472 | 123.6 | 01111011 b | 2666 h | 1 Ah |
| 2484 | 124.2 | 01111100 b | 0 CCCh | 33 h |

## Crystal Oscillator

The crystal oscillator has been optimized to work with low-cost crystals (e.g., Kyocera CX-3225SB). See Figure 2. The crystal oscillator frequency can be fine tuned through bits D6:D0 in Register 14 (A3:A0 = 1110), which control the value of $\mathrm{C}_{\text {TUNE }}$ from 0.5 pF to 15.4 pF in 0.12 pF steps. See the Crystal-Oscillator Offset Frequency vs. Crystal-Oscillator Tuning Bits graph in the Typical Operating Characteristics. The crystal oscillator can be used as a buffer for an external reference frequency source. In this case, the reference signal is ACcoupled to the XTAL pin, and capacitors C1 and C2 are not connected. When used as a buffer, the XTAL input pin has to be AC-coupled. The XTAL pin has an input impedance of $5 \mathrm{k} \Omega \| 4 \mathrm{pF}$, (set D6:D0 $=0000000$ in Register $14 \mathrm{AB}: \mathrm{AO}=1110$ ).


Figure 2. Crystal Oscillator Schematic

Reference Clock Output Divider/Buffer
The reference oscillator of the MAX2830 has a divider and a buffered output for routing the reference clock to the accompanying baseband IC. Bit D10 in Register 14 $(A 3: A 0=1110)$ sets the buffer divider to divide by 1 or 2 , independent of the divide ratio for the reference frequency provided to the PLL. Bit B9 in the same register enables or disables the reference buffer output. See the Clock Output waveform in the Typical Operating Characteristics.

Loop Filter The PLL charge-pump output, CPOUT (pin 24), connects to an external third-order, lowpass RC loop-filter, which in turn connects to the voltage tuning input, TUNE (pin 32), of the VCO, completing the PLL loop. The charge-pump output sink and source current is 1 mA , and the VCO tuning gain is $103 \mathrm{MHz} / \mathrm{V}$ at 0.5 V tune voltage and $86 \mathrm{MHz} / \mathrm{V}$ at 2.2 V tune voltage. The RC loop-filter values have been optimized for a loop bandwidth of 150 kHz , to achieve the desired $\mathrm{Rx} / \mathrm{Tx}$ turnaround settling time, while maintaining loop stability and good phase noise. Refer to the MAX2830 EV kit schematic for the recommended loop-filter component values. Keep the line from this pin to the tune input as short as possible to prevent spurious pickup.

## Lock-Detector Output

The PLL features a logic lock-detect output. A logic-high indicates the PLL is locked, and a logic-low indicates the PLL is not locked. Bit D5 in Register 5 (A3:A0 = 0101) enables or disables the lock-detect output. Bit

### 2.4GHz to 2.5GHz 802.11 g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

D12 in Register $1(\mathrm{~A} 3: A 0=0001)$ configures the lockdetect output as a CMOS or open-drain output. In opendrain output mode, bit D9 in Register $5(\mathrm{~A} 3: \mathrm{AO}=0101)$ enables or disables an internal $30 \mathrm{k} \Omega$ pullup resistor from the open-drain output.

## Programmable Registers and 3-Wire SPI-Interface

 The MAX2830 includes 16 programmable, 18-bit registers. The 14 most significant bits (MSBs) are used for register data. The 4 least significant bits (LSBs) of each register contain the register address. See Table 15 for a summary of the registers and recommended register settings.Register data is loaded through the 3-wire SPI/ MICROWIRE ${ }^{\text {TM }}$-compatible serial interface. Data is shifted in MSB first and is framed by $\overline{\mathrm{CS}}$. When $\overline{\mathrm{CS}}$ is low, the clock is active, and data is shifted with the rising edge of the clock. When $\overline{\mathrm{CS}}$ transitions high, the shift register is latched into the register selected by the contents of the address bits. See Figure 3. Only the last 18 bits shifted into the device are retained in the shift register. No check is made on the number of clock pulses. For programming data words less than 14 bits long, only the required data bits and the address bits need to be shifted, resulting in faster $R x$ and $T x$ gain control where only the LSBs need to be programmed.

Table 15. Recommended Register Settings*

| REGISTER | DATA |  |  |  |  |  |  |  |  |  |  |  |  |  | ADDRESS | TABLE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | (A3:A0) |  |
| 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0000 | 15 |
| 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0001 | 16 |
| 2 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0010 | 17 |
| 3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0011 | 18 |
| 4 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0100 | 19 |
| 5 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0101 | 20 |
| 6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0110 | 21 |
| 7 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0111 | 22 |
| 8 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1000 | 23 |
| 9 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1001 | 24 |
| 10 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1010 | 25 |
| 11 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1011 | 26 |
| 12 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1100 | 27 |
| 13 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1101 | 28 |
| 14 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1110 | 29 |
| 15 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1111 | 30 |

*The power-on register settings are not production tested. Recommended register settings must be loaded after $V_{C C}$ is supplied.


Figure 3. 3-Wire SPI Serial-Interface Timing Diagram

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Table 16. Register $0(A 3: A 0=0000)$

| DATA BITS | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D11 | 000 | Set to recommended value. |
| D10 | 1 | Fractional-N PLL Mode Enable. Set 1 to enable the fractional-N PLL or set 0 to enable the <br> integer-N PLL. |
| D9:D0 | 1101000000 | Set to recommended value. |

Table 17. Register 1 (A3:A0 = 0001)

| DATA BITS | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13 | 0 | Set to recommended value. |
| D12 | 1 | Lock-Detector Output Select. Set to 1 for CMOS Output. Set to 0 for open-drain output. Bit D9 <br> in register (A3:A0 = 0101) enables or disables an internal 30k $\Omega$ pullup resistor in open-drain <br> output mode. |
| D11:D0 | 000110011010 | Set to recommended value. |

Table 18. Register $2(\mathrm{~A} 3: A 0=0010)$

| DATA BITS | RECOMMENDED |  | DESCRIPTION |
| :---: | :---: | :--- | :--- |
| D13:D0 | 01000000000011 | Set to recommended value. |  |

This register contains the 8-bit integer portion and 6 LSBs of the fractional portion of the divider ratio of the synthesizer.
Table 19. Register $3(\mathrm{~A}: \mathrm{AO}=\mathbf{0 0 1 1})$

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D8 | 00000 | 6 LSBs of 20-Bit Fractional Portion of Main Divider |
| D7:D0 | 01111001 | 8-Bit Integer Portion of Main Divider. Programmable from 64 to 255. |

Table 20. Register $4(\mathrm{~A} 3: A 0=0100)$

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D0 | 11011001100110 | 14 MSBs of 20-Bit Fractional Portion of Main Divider |

Table 21. Register 5 (A3:A0 = 0101)

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D10 | 0000 | Set to recommended value. |
| D9 | 0 | Lock-Detect Output Internal Pullup Resistor Enable. Set to 1 to enable internal 30k $\Omega$ pullup <br> resistor or set to 0 to disable the resistor. Only available when lock-detect, open-drain output <br> is selected (A3:A0 = 0001, D12 = 1). |
| D8:D6 | 010 | Set to recommended value. |
| D5 | 1 | Lock-Detect Output Enable. Set to 1 to enable the lock-detect output or set to 0 to disable the <br> output. The output is high impedance when disabled. |
| D4:D3 | 00 | Set to recommended value. |
| D2 | 1 | Reference Frequency Divider Ratio to PLL. Set to 0 to divide by 1. Set to 1 to divide by 2. |
| D1:D0 | 00 | Set to recommended value. |

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Table 22. Register $6(A 3: A 0=0110)$

| DATA BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13 | 0 | Set to recommended value. |
| D12:D11 | 00 | Tx I/Q Calibration LO Leakage and Sideband Detector Gain-Control Bits. D12:D11 = 00: $9 \mathrm{~dB} ;$ <br> $0119 \mathrm{~dB} ; 10: 29 \mathrm{~dB} ; 11: 39 \mathrm{~dB}$. |
| D10:D7 | 0000 | Set to recommended value. |
| D6 | 1 | Power-Detector Enable in Tx Mode. Set to 1 to enable the power detector or set to 0 to <br> disable the detector. |
| D5:D2 | 1000 | Set to recommended value. |
| D1 | 0 | Tx Calibration Mode. Set to 1 to place the device in Tx calibration mode or 0 to place the <br> device in normal Tx mode when RXTX is set to 1 (see Table 32). |
| D0 | 0 | Rx Calibration Mode. Set to 1 to place the device in Rx calibration mode or 0 to place the <br> device in normal Rx mode when RXTX is set to 0 (see Table 32). |

Table 23. Register $7(A 3: A 0=0111)$

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D12 | 01 | Receiver Highpass Corner Frequency Setting for RXHP $=0$. Set to 00 for $100 \mathrm{~Hz}, \mathrm{X} 1$ for 4 kHz, <br> and 10 for 30kHz. |
| D11:D6 | 000000 | Set to recommended value. |
| D5:D3 | 100 | Transmitter Lowpass Filter Corner Frequency Fine Adjustment (Relative to Coarse Setting). <br> See Table 9. Bits D1:D0 in A3:A0 $=1000$ provide the lowpass filter corner coarse adjustment. |
| D2:D0 | 010 | Receiver Lowpass Filter Corner Frequency Fine Adjustment (Relative to Coarse Setting). See <br> Table 6. Bits D1:D0 in A3:A0 $=1000$ provide the lowpass filter corner coarse adjustment. |

Table 24. Register 8 (A3:A0 = 1000)

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13 | 1 | Set to recommended value. |
| D12 | 0 | Enable Receiver Gain Programming Through the Serial Interface. Set to 1 to enable <br> programming through the 3-wire serial interface (D6:D0 in Register A3:A0 = 1011). Set to 0 to <br> enable programming in parallel through external digital pins (B7:B1). |
| D11 | 0 | Set to recommended value. |
| D10 | 0 | RSSI Operating Mode. Set to 1 to enable RSSI output independent of RXHP. Set to 0 to <br> disable RSSI output if RXHP = 0, and enable the RSSI output if RXHP = 1. |
| D9:D8 | 00 | RSSI, Power Detector, or Temperature Sensor Output Select. Set to 00 to enable the RSSI <br> output in receive mode. Set to 01 to enable the temperature sensor output in receive and <br> transmit modes. Set to 10 to enable the power-detector output in transmit mode. See Table 7. |
| D7:D2 | 001000 | Set to recommended value. |
| D1:D0 | 01 | Receiver and Transmitter Lowpass Filter Corner Frequency Coarse Adjustment. See Tables 4 <br> and 7. |

### 2.4GHz to 2.5 GHz 802.11 g/b RF Transceiver, PA,

 and Rx/Tx/Antenna Diversity SwitchTable 25. Register 9 (A3:A0 = 1001)

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D11 | 000 | Set to recommended value. |
| D10 | 0 | Enable Transmitter Gain Programming Through the Serial or Parallel Interface. Set to 1 to <br> enable programming through the 3-wire serial interface (D5:D0 in Register A3:A0 = 1011). <br> Set to 0 to enable programming in parallel through external digital pins (B6:B1). |
| D9:D0 | 1110110101 | Set to recommended value. |

Table 26. Register 10 (A3:A0 = 1010)

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D10 | 0111 | Power-Amplifier Enable Delay. Sets a delay between RXTX low-to-high transition and internal PA <br> enable. Programmable in 0.5 s steps. D13:D10 $=0001(0.2 \mu \mathrm{~s})$ and D13:D10 $=1111(7 \mu \mathrm{~s})$. |
| D9:D7 | 011 | Set to recommended value. |
| D6:D3 | 0100 | Second-Stage Power-Amplifier Bias Current Adjustment. Set to XXXX for 802.11g/b. |
| D2:D0 | 100 | First-Stage Power-Amplifier Bias Current Adjustment. Set to XXX for 802.11g/b. |

Table 27. Register 11 (A3:A0 = 1011)

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D7 | 0000000 | Set to recommended value. |
| D6:D5 | 11 | LNA Gain Control. Set to 11 for high-gain mode. Set to 10 for medium-gain mode, reducing <br> LNA gain by 16dB. Set to 0X for low-gain mode, reducing LNA gain by 33dB. |
| D4:D0 | 11111 | Receiver VGA Control. Set D4:D0 $=00000$ for minimum gain and D4:D0 $=11111$ for <br> maximum gain. |

Table 28. Register $12(A 3: A 0=1100)$

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D6 | 00000101 | Set to recommended value. |
| D5:D0 | 000000 | Transmitter VGA Gain Control. Set D5:D0 = 000000 for minimum gain, and set D5:D0 = <br> 111111 for maximum gain. |

Table 29. Register 13 (A3:A0 = 1101)

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D10 | 0011 | Set to recommended value. |
| D9:D6 | 1010 | Set to recommended value. |
| D5:D0 | 010010 | Set to recommended value. | and Rx/Tx/Antenna Diversity Switch

Table 30. Register $14(A 3: A 0=1110)$

| BIT | RECOMMENDED |  |
| :---: | :---: | :--- |
| D13:D11 | 000 | Set to recommended value. |
| D10 | 0 | Reference Clock Output Divider Ratio. Set 1 to divide by 2 or set 0 to divide by 1. |
| D9 | 1 | Reference Clock Output Enable. Set 1 to enable the reference clock output or set 0 to disable. |
| D8:D7 | 10 | Set to recommended value. |
| D6:D0 | XXXXXXX | Crystal-Oscillator Fine Tune. Tunes crystal oscillator over $\pm 20 \mathrm{ppm}$ to within $\pm 1$ ppm. |

$X=$ Don't care.

Table 31. Register 15 (A3:A0 = 1111)

| BIT | RECOMMENDED | DESCRIPTION |
| :---: | :---: | :--- |
| D13:D12 | 00 | Set to recommended value. |
| D11:D10 | 00 | Receiver I/Q Output Common-Mode Voltage Adjustment. Set D11:D10 = 00: 1.1V, <br> 01: 1.2V, 10: 1.3V, 11: 1.45V. |
| D9:D0 | 0101000101 | Set to recommended value. |

Table 32. Operating Mode Table

| MODE | LOGIC PINS |  | REGISTER <br> SETTINGS | CIRCUIT BLOCK STATES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SHDN | RXTX | D1:D0 <br> (A3:A0 = 0110) | Rx PATH | Tx PATH | PLL, VCO, <br> LO GEN, <br> AUTOTUNER | CALIBRATION <br> SECTIONS ON |
|  | 0 | 0 | 00 | Off | Off | Off | None |
| Standby | 0 | 1 | 00 | Off | Off | On | None |
| Rx | 1 | 0 | X0 | On | Off | On | None |
| Tx | 1 | 1 | $0 X$ | Off | On | On | None |
| Rx Calibration | 1 | 0 | $X 1$ | On <br> (except LNA) | Upconverters | On | Cal tone, RF phase <br> shift, Tx filter |
| Tx Calibration | 1 | 1 | $1 \times$ | Off | On (except PA <br> driver and PA) | On | AM detector, <br> Rx I/Q buffers |

$X=$ Don't care.
Note: See Table 1 for $R x / T x$ and antenna diversity operating mode.

## Modes of Operation

The modes of operation for the MAX2830 are shutdown, standby, transmit, receive, transmitter calibration, and receiver calibration. See Table 32 for a summary of the modes of operation. The logic-input pins, SHDN (pin 12) and RXTX (pin 48), control the various modes.

## Shutdown Mode

The MAX2830 features a low-power shutdown mode that disables all circuit blocks, except the serial-interface and internal registers, allowing the registers to be
loaded and values maintained, as long as $\mathrm{V}_{\mathrm{CC}}$ is applied. Set SHDN and RXTX logic-low to place the device in shutdown mode. After a supply voltage ramp up, supply current in shutdown mode could be high. Program the default value to SPI register 0 to eliminate high shutdown current.

## Standby Mode

The standby mode is used to enable the frequency synthesizer block while the rest of the device is powered down. In this mode, the PLL, VCO, and LO generators

# 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch 

are on, so that Tx or Rx modes can be quickly enabled from this mode. Set $\overline{\text { SHDN }}$ to a logic-low and RXTX to a logic-high to place the device in standby mode.

Receive (Rx) Mode
The complete receive signal path is enabled in this mode. Set SHDN to logic-high and RXTX to logic-low to place the device in Rx mode.

Transmit (Tx) Mode
The complete transmitter signal path is enabled in this mode. Set SHDN and RXTX to logic-high to place the device in Tx mode.

## Rx/Tx Calibration Mode

The MAX2830 features Rx/Tx calibration modes to detect I/Q imbalances and transmit LO leakage. In the Tx calibration mode, all Tx circuit blocks, except the PA driver and external PA, are powered on and active. The AM detector and receiver I and Q channel buffers are also on, along with multiplexers in the receiver side to route this AM detector's signal. In this mode, the LO leakage calibration is done only for the LO leakage signal that is present at the center frequency of the channel (i.e., in the middle of the OFDM or QPSK spectrum). The LO leakage calibration includes the effect of all DC offsets in the entire baseband paths of the I/Q modulator and direct leakage of the LO to the I/Q modulator output.
The LO leakage and sideband detector output are taken at the receiver I and Q channel outputs during this calibration phase.
During Tx LO leakage and I/Q imbalance calibration, a sine and cosine signal ( $f=f_{\text {TONE }}$ ) is input to the baseband I/Q Tx pins from the baseband IC. At the LO leakage and sideband-detector output, the LO leakage corresponds to the signal at $\mathrm{f}_{\text {TONE }}$ and the sideband suppression corresponds to the signal at $2 \times f_{\text {TONE }}$. The output power of these signals vary 1 dB for 1 dB of variation in the LO leakage and sideband suppression. To
calibrate the Tx path, first set the power-detector gain to 9dB using D12:D11 in Register 6 (see Table 22). Adjust the DC offset of the baseband inputs to minimize the signal at $\mathrm{f}_{\text {TONE }}$ (LO leakage). Then, adjust the baseband input relative magnitude and phase offsets to reduce the signal at $2 \times \mathrm{f}_{\text {TONE }}$.
In Rx calibration mode, the calibrated Tx RF signal is internally routed to the Rx inputs. In this mode, the VCO/LO generator/PLL blocks are powered on and active except for the low-noise amplifier (LNA).

## Applications Information

## Layout Issues

The MAX2830 EV kit can be used as a starting point for layout. For best performance, take into consideration grounding and RF, baseband, and power-supply routing. Make connections from vias to the ground plane as short as possible. Do not connect the device ground pin to the exposed paddle ground. Keep the buffered clock output trace as short as possible. Do not share the trace with the RF input layer, especially on or interlayer or back side of the board. On the high-impedance ports, keep traces short to minimize shunt capacitance. EV kit Gerber files can be requested at www.maxim-ic.com.

Power-Supply Layout
To minimize coupling between different sections of the IC, a star power-supply routing configuration with a large decoupling capacitor at a central VCC node is recommended. The Vcc traces branch out from this node, each going to a separate VCC node in the circuit. Place a bypass capacitor as close as possible to each supply pin. This arrangement provides local decoupling at each Vcc pin. Use at least one via per bypass capacitor for a low-inductance ground connection. Do not share the capacitor ground vias with any other branch and the exposed paddle ground.

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Figure 4. Timing Diagram

Pin Configuration


Chip Information
PROCESS: BiCMOS
Package Information
For the latest package outline information and land patterns (footprints), go to www.maxim-ic.com/packages. Note that a "+", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE <br> TYPE | PACKAGE <br> CODE | OUTLINE NO. | LAND <br> PATTERN NO. <br> 48 TQFN-EP |
| :---: | :---: | :---: | :---: |
| T4877+4 | $\underline{21-0144}$ | $\underline{90-0130}$ |  |

MAX2830

### 2.4GHz to 2.5GHz 802.11g/b RF Transceiver, PA, and Rx/Tx/Antenna Diversity Switch

Revision History

| REVISION <br> NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES <br> CHANGED |
| :---: | :---: | :--- | :---: |
| 0 | $3 / 07$ | Initial release | - |
| 1 | $7 / 09$ | Corrected Table 12 | 24 |
| 2 | $3 / 11$ | Corrected conditions for Rx I/Q Output Common-Mode Voltage Variation in the DC <br> Electrical Characteristics; corrected Tables 15 and 31; added text to Shutdown Mode <br> section | $2,26,30$ |

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[^0]:    $x=$ Don't care.

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